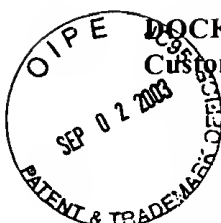


#17



DOCKET NO. 97-C-108 (STMI01-97108)
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Tsiu Chiu Chan, et al.
Serial No. : 09/160,824
Filed : September 25, 1998
For : STACKED MULTI-COMPONENT INTEGRATED CIRCUIT
Group No. : 2826
Examiner : T. Dickey

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

PETITION UNDER 37 C.F.R. § 1.47(a)

A Request for Continued Examination (RCE) is being concurrently filed in the above-identified application, together with a Declaration establishing invention of the subject matter of the rejected claims in the above-identified application prior to the effective date of the reference on which the rejection is based, pursuant to 37 C.F.R. § 1.131 and MPEP § 715.

However, the Declaration is not signed by ALL inventors as required under MPEP § 715..04. Accordingly, Applicants respectfully petition under 37 C.F.R. 1.47(a) that the declaration and/or application be made by the signing inventor(s) on behalf of themselves and the non-signing inventor, who cannot be found or reached after diligent effort.

09/03/2003 HDEMESS1 00000066 09160824
02 FC:1460 130.00 DP

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The undersigned hereby certifies that the letter attached to this Petition, together with a copy of the Declaration and attachments, was sent via United States Postal Service air mail, with sufficient postage, to the last known address of the non-signing inventor:

Mr. Arnaud Lepert
110 Impasse de l'eau vive
38210 Vourey
FRANCE

As reflected by the attached copy of the envelope in which such letter, Declaration and attachments was sent, the correspondence was returned as undeliverable at the last known address for the non-signing inventor.

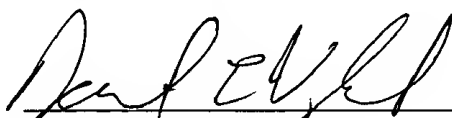
A check for the fee of \$130.00 under 37 C.F.R. 1.17(h) is enclosed.

Applicants respectfully request that the declaration made by the two signing inventors be entered on their behalf and that of the non-signing inventor.

Respectfully submitted,

DAVIS MUNCK, P.C.

Date: 8-25-03



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May 14, 2003

CONFIDENTIAL AND PRIVILEGED ATTORNEY-CLIENT COMMUNICATION

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Carrollton, Texas 75006

Mr. Larry Eng
3315 Water Oak
Dallas, Texas 75234

Mr. Arnaud Lepert
110 Impasse de l'eau vive
38210 Vourey
France

Re: U.S. Patent Application Serial No. 09/160,824 for "STACKED MULTI-COMPONENT INTEGRATED CIRCUIT"
STMicroelectronics Ref: 97-C-108
Our File: STM101-97108

Gentlemen:

Enclosed for your signature please find a Declaration under 37 C.F.R. § 1.131 to overcome a pending rejection in the above-identified application. Please sign and date the Declaration in the space(s) provided, and return it to us for filing in the U.S. Patent and Trademark Office. A self-addressed, stamped envelope is enclosed for return of the signed Declaration.

Please do not hesitate to contact me if you have any questions regarding this Declaration.

Best regards,

DAVIS MUNCK, P.C.

Daniel E. Venglarik

DEV/kl
Enclosures

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OFFICE OF PETITIONS



Mr. Arnaud Lepert
116 Impasse de l'eau vive
38210 Vourey
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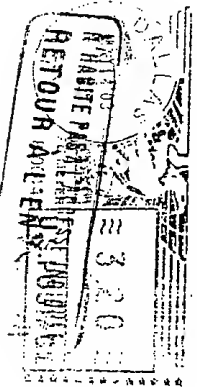
900 THREE GALLERIA TOWER
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DAVISMUNCK
TRADEMARK TECHNOLOGY

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AIR MAIL

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